

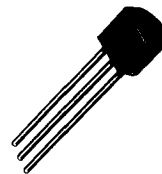
# MPS3640 (SILICON)

## PNP SILICON ANNULAR TRANSISTOR

... designed for general-purpose, low-level switching applications.

- Low Collector-Emitter Saturation Voltage –  
 $V_{CE(sat)} = 0.2 \text{ Vdc} @ I_C = 10 \text{ mAdc}$
- Output Capacitance –  
 $C_{ob} = 3.5 \text{ pF (Max) @ } V_{CB} = 5.0 \text{ Vdc}$
- Fast Switching Time @  $I_C = 50 \text{ mAdc}$   
 $t_{on} = 25 \text{ ns (Max)}$   
 $t_{off} = 35 \text{ ns (Max)}$

## PNP SILICON SWITCHING TRANSISTOR



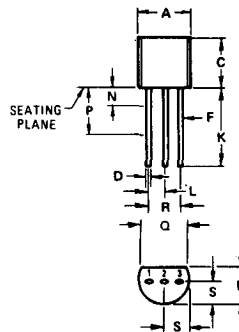
### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector-Emitter Voltage	$V_{CEO}$	12	Vdc
Collector-Base Voltage	$V_{CB}$	12	Vdc
Emitter-Base Voltage	$V_{EB}$	4.0	Vdc
Collector Current – Continuous	$I_C$	80	mAdc
Total Power Dissipation @ $T_A = 25^\circ\text{C}$ Derate above $25^\circ\text{C}$	$P_D$	350 2.8	mW mW/ $^\circ\text{C}$
Total Power Dissipation @ $T_C = 25^\circ\text{C}$ Derate above $25^\circ\text{C}$	$P_D$	1.0 8.0	Watt mW/ $^\circ\text{C}$
Operating and Storage Junction Temperature Range	$T_J, T_{stg}$	-55 to +150	$^\circ\text{C}$

### THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Ambient	$R_{\theta JA}(1)$	357	$^\circ\text{C/W}$
Thermal Resistance, Junction to Case	$R_{\theta JC}$	125	$^\circ\text{C/W}$

(1)  $R_{\theta JA}$  is measured with the device soldered into a typical printed circuit board.



STYLE 1:  
 PIN 1. EMITTER  
 2. BASE  
 3. COLLECTOR

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	4.450	5.200	0.175	0.206
B	3.180	4.190	0.125	0.165
C	4.320	5.330	0.170	0.210
D	0.407	0.533	0.016	0.021
F	0.407	0.482	0.016	0.019
K	12.700	—	0.500	—
L	1.150	1.390	0.045	0.055
N	—	1.270	—	0.050
P	6.350	—	0.250	—
Q	3.430	—	0.135	—
R	2.410	2.670	0.095	0.105
S	2.030	2.670	0.080	0.105

CASE 29-02  
 TO-92

**ELECTRICAL CHARACTERISTICS** ( $T_A = 25^\circ\text{C}$  unless otherwise noted.)

Characteristic	Symbol	Min	Max	Unit
<b>OFF CHARACTERISTICS</b>				
Collector-Emitter Sustaining Voltage (1) ( $I_C = 10 \text{ mA}$ , $I_B = 0$ )	$V_{CE(sus)}$	12	—	Vdc
Collector-Emitter Breakdown Voltage ( $I_C = 100 \mu\text{A}$ , $V_{BE} = 0$ )	$BV_{CES}$	12	—	Vdc
Collector-Base Breakdown Voltage ( $I_C = 100 \mu\text{A}$ , $I_E = 0$ )	$BV_{CBO}$	12	—	Vdc
Emitter-Base Breakdown Voltage ( $I_E = 100 \mu\text{A}$ , $I_C = 0$ )	$BV_{EBO}$	4.0	—	Vdc
Collector Cutoff Current ( $V_{CE} = 6.0 \text{ Vdc}$ , $V_{BE} = 0$ ) ( $V_{CE} = 6.0 \text{ Vdc}$ , $V_{BE} = 0$ , $T_A = 65^\circ\text{C}$ )	$I_{CES}$	—	0.01 1.0	$\mu\text{A}$
Reverse Base Current ( $V_{CE} = 6.0 \text{ Vdc}$ , $V_{BE} = 0$ )	$I_B$	—	10	nA
<b>ON CHARACTERISTICS (1)</b>				
DC Current Gain ( $I_C = 10 \text{ mA}$ , $V_{CE} = 0.3 \text{ Vdc}$ ) ( $I_C = 50 \text{ mA}$ , $V_{CE} = 1.0 \text{ Vdc}$ )	$h_{FE}$	30 20	120 —	—
Collector-Emitter Saturation Voltage ( $I_C = 10 \text{ mA}$ , $I_B = 1.0 \text{ mA}$ ) ( $I_C = 50 \text{ mA}$ , $I_B = 5.0 \text{ mA}$ ) ( $I_C = 10 \text{ mA}$ , $I_B = 1.0 \text{ mA}$ , $T_A = 65^\circ\text{C}$ )	$V_{CE(sat)}$	— — —	0.2 0.6 0.25	Vdc
Base-Emitter Saturation Voltage ( $I_C = 10 \text{ mA}$ , $I_B = 0.5 \text{ mA}$ ) ( $I_C = 10 \text{ mA}$ , $I_B = 1.0 \text{ mA}$ ) ( $I_C = 50 \text{ mA}$ , $I_B = 5.0 \text{ mA}$ )	$V_{BE(sat)}$	0.75 0.8 —	0.95 1.0 1.5	Vdc
<b>DYNAMIC CHARACTERISTICS</b>				
Current-Gain-Bandwidth Product ( $I_C = 10 \text{ mA}$ , $V_{CE} = 5.0 \text{ Vdc}$ , $f = 100 \text{ MHz}$ )	$f_T$	500	—	MHz
Output Capacitance ( $V_{CB} = 5.0 \text{ Vdc}$ , $I_E = 0$ , $f = 140 \text{ kHz}$ )	$C_{ob}$	—	3.5	pF
Input Capacitance ( $V_{BE} = 0.5 \text{ Vdc}$ , $I_C = 0$ , $f = 140 \text{ kHz}$ )	$C_{ib}$	—	3.5	pF
<b>SWITCHING CHARACTERISTICS</b>				
Turn-On Time ( $V_{CC} = 6.0 \text{ Vdc}$ , $I_C = 50 \text{ mA}$ , $V_{BE(off)} = 1.9 \text{ Vdc}$ , $I_{B1} = 5.0 \text{ mA}$ ) (Figure 1) ( $V_{CC} = 1.5 \text{ Vdc}$ , $I_C = 10 \text{ mA}$ , $I_{B1} = 0.5 \text{ mA}$ ) (Figure 2)	$t_{on}$	— —	25 60	ns
Delay Time ( $V_{CC} = 6.0 \text{ Vdc}$ , $I_C = 50 \text{ mA}$ , $V_{BE(off)} = 1.9 \text{ Vdc}$ , $I_{B1} = 5.0 \text{ mA}$ ) (Figure 1)	$t_d$	—	10	ns
Rise Time ( $I_{B1} = 5.0 \text{ mA}$ ) (Figure 1)	$t_r$	—	30	ns
Turn-Off Time ( $V_{CC} = 6.0 \text{ Vdc}$ , $I_C = 50 \text{ mA}$ , $I_{B1} = I_{B2} = 5.0 \text{ mA}$ ) (Figure 1) ( $V_{CC} = 1.5 \text{ Vdc}$ , $I_C = 10 \text{ mA}$ , $I_{B1} = I_{B2} = 0.5 \text{ mA}$ ) (Figure 2)	$t_{off}$	— —	35 75	ns
Storage Time ( $V_{CC} = 6.0 \text{ Vdc}$ , $I_C = 50 \text{ mA}$ , $I_{B1} = I_{B2} = 5.0 \text{ mA}$ )	$t_s$	—	20	ns
Fall Time (Figure 1)	$t_f$	—	12	ns

(1) Pulse Test: Pulse Width  $\leq 300 \mu\text{s}$ , Duty Cycle  $\leq 2.0\%$ .

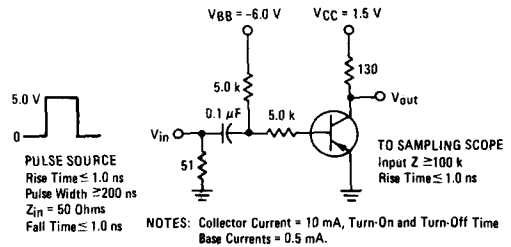
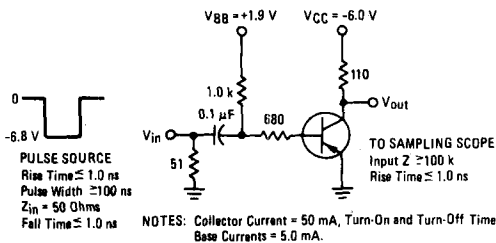


FIGURE 3 - DC CURRENT GAIN

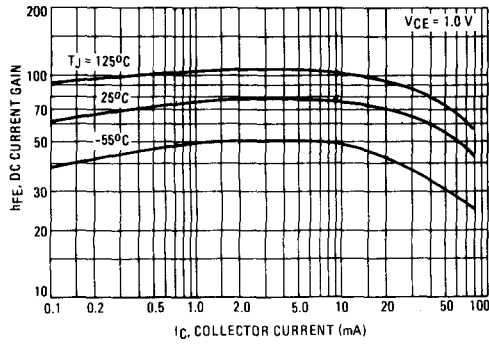


FIGURE 4 - "ON" VOLTAGES

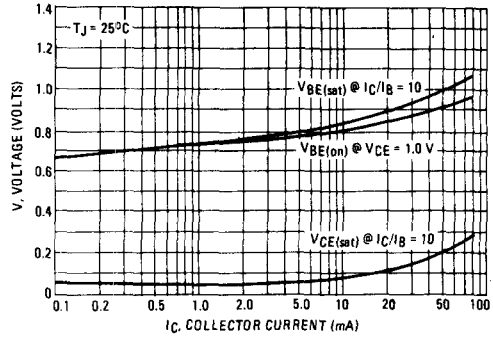


FIGURE 5 - COLLECTOR SATURATION REGION

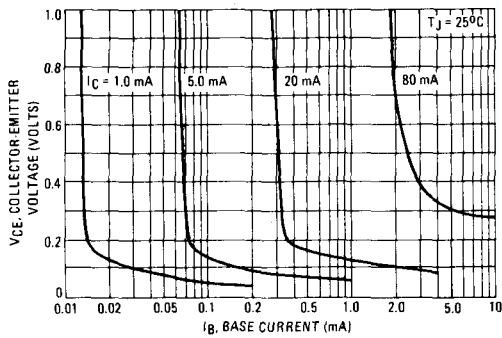


FIGURE 6 - TEMPERATURE COEFFICIENTS

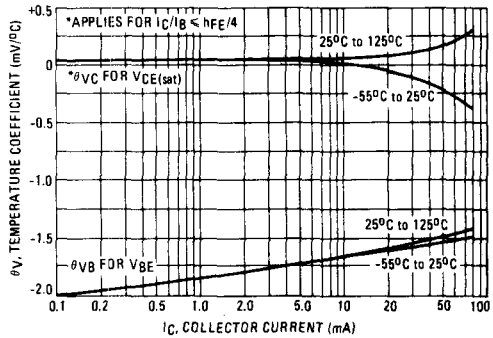


FIGURE 7 - CURRENT-GAIN-BANDWIDTH PRODUCT

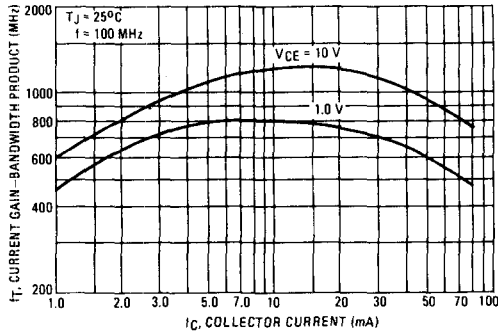


FIGURE 8 - CAPACITANCE

